



ALPHA & OMEGA
SEMICONDUCTOR

AOT10N60/AOB10N60/AOTF10N60 600V, 10A N-Channel MOSFET

General Description

The AOT10N60 & AOB10N60 & AOTF10N60 have been fabricated using an advanced high voltage MOSFET process that is designed to deliver high levels of performance and robustness in popular AC-DC applications. By providing low $R_{DS(on)}$, C_{iss} and C_{rss} along with guaranteed avalanche capability these parts can be adopted quickly into new and existing offline power supply designs.

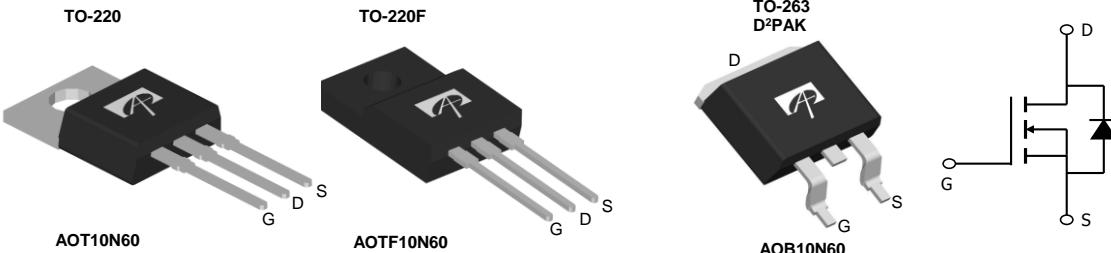
Product Summary

V_{DS}	700V@150°C
I_D (at $V_{GS}=10V$)	10A
$R_{DS(on)}$ (at $V_{GS}=10V$)	< 0.75Ω

100% UIS Tested
100% R_g Tested



Top View



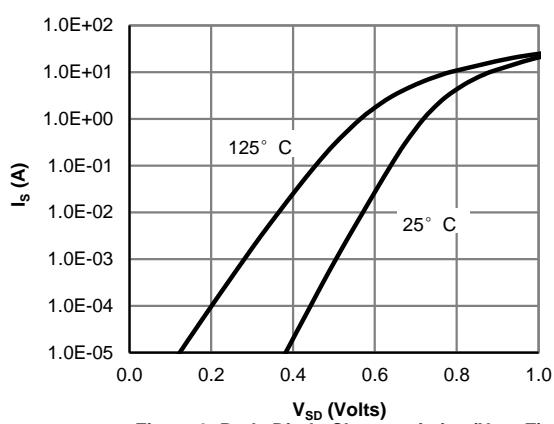
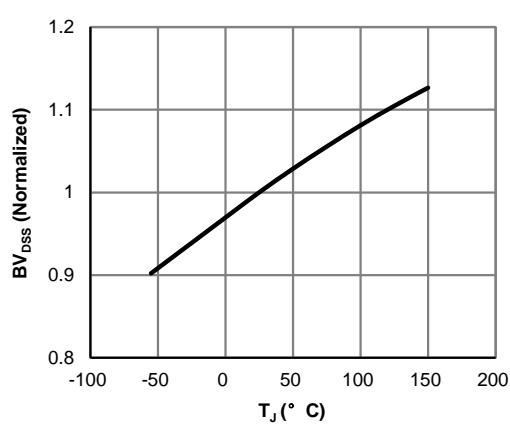
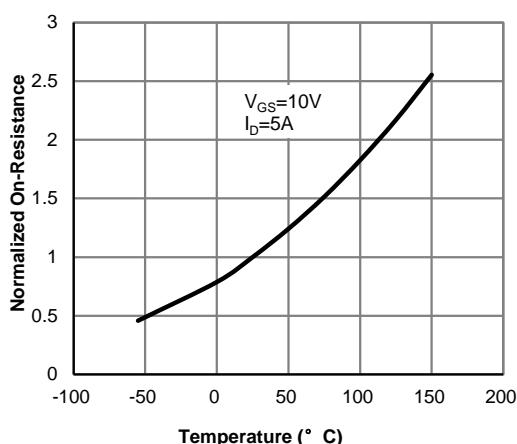
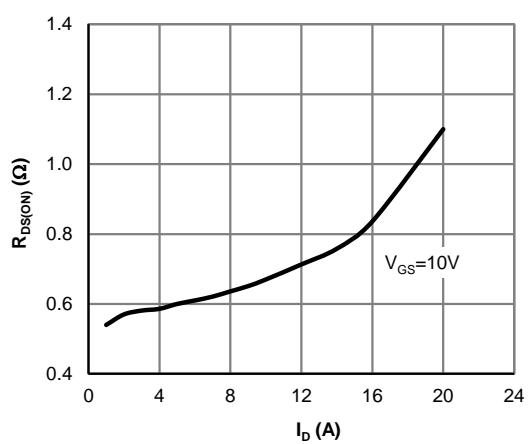
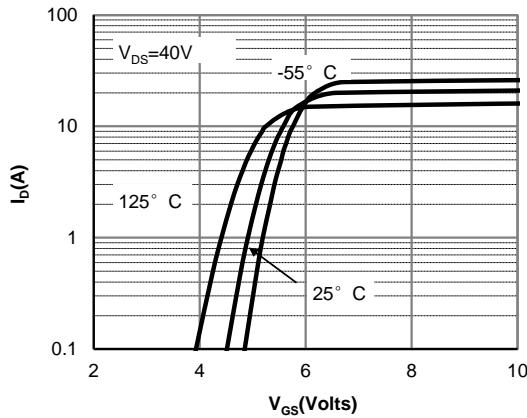
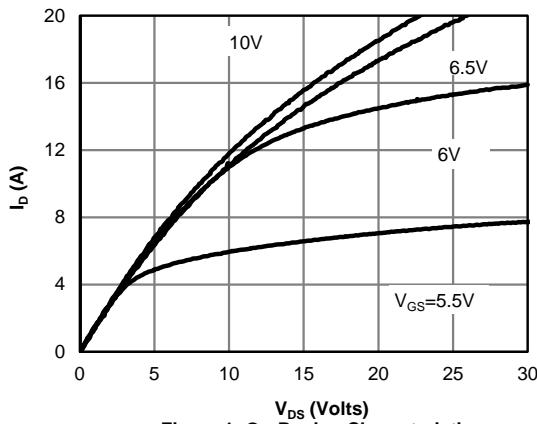
Absolute Maximum Ratings $T_A=25^\circ C$ unless otherwise noted

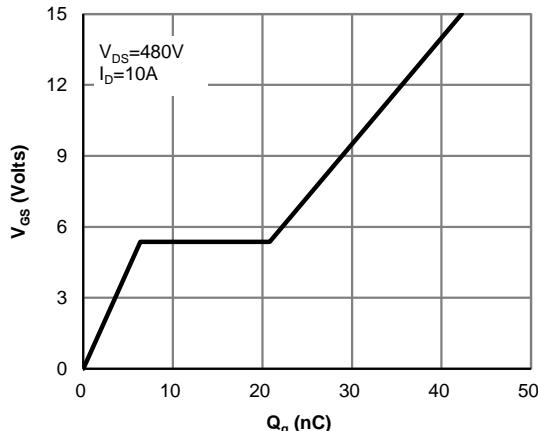
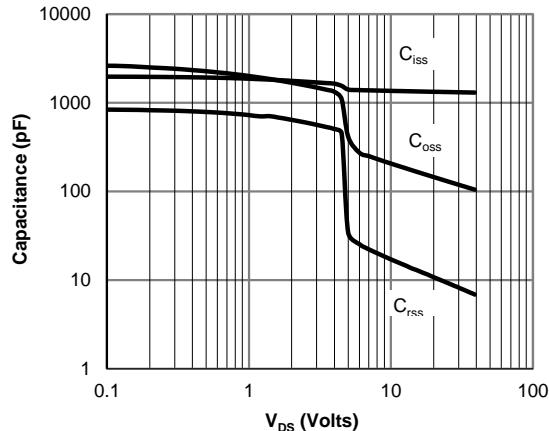
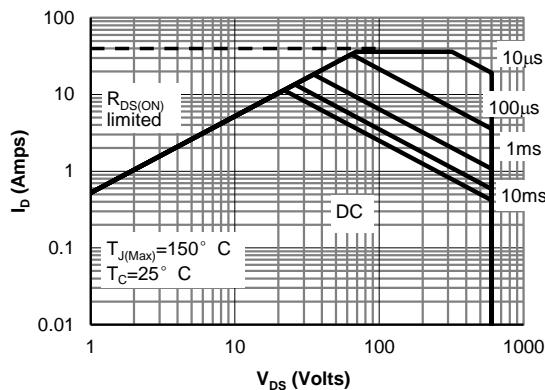
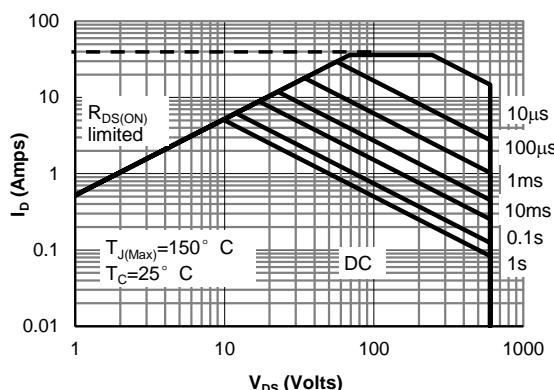
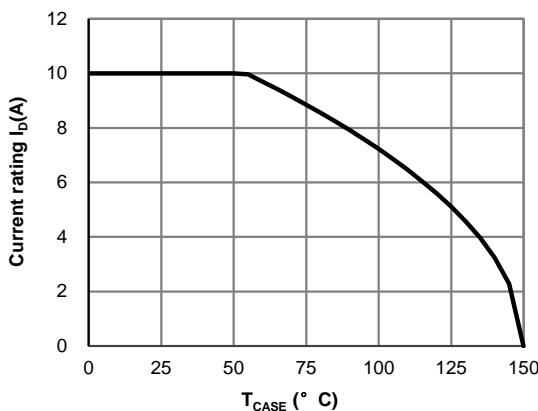
Parameter	Symbol	AOT10N60/AOB10N60	AOTF10N60	Units
Drain-Source Voltage	V_{DS}	600		V
Gate-Source Voltage	V_{GS}	± 30		V
Continuous Drain Current	I_D <small>$T_C=25^\circ C$</small>	10	10*	A
	I_D <small>$T_C=100^\circ C$</small>	7.2	7.2*	
Pulsed Drain Current ^C	I_{DM}	36		
Avalanche Current ^C	I_{AR}	4.4		A
Repetitive avalanche energy ^C	E_{AR}	290		mJ
Single plused avalanche energy ^G	E_{AS}	580		mJ
MOSFET dv/dt ruggedness	dv/dt	45		V/ns
Peak diode recovery dv/dt		5		
Power Dissipation ^B	P_D <small>$T_C=25^\circ C$</small>	250	50	W
	P_D <small>Derate above 25°C</small>	2	0.4	W/°C
Junction and Storage Temperature Range	T_J, T_{STG}	-55 to 150		°C
Maximum lead temperature for soldering purpose, 1/8" from case for 5 seconds	T_L	300		°C

Thermal Characteristics

Parameter	Symbol	AOT10N60/AOB10N60	AOTF10N60	Units
Maximum Junction-to-Ambient ^{A,D}	$R_{\theta JA}$	65	65	°C/W
Maximum Case-to-sink ^A	$R_{\theta CS}$	0.5	--	°C/W
Maximum Junction-to-Case	$R_{\theta JC}$	0.5	2.5	°C/W

* Drain current limited by maximum junction temperature.

TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


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Figure 7: Gate-Charge Characteristics

Figure 8: Capacitance Characteristics

Figure 9: Maximum Forward Biased Safe Operating Area for AOT10N60/AOB10N60 (Note E)

Figure 10: Maximum Forward Biased Safe Operating Area for AOTF10N60 (Note F)

Figure 11: Current De-rating (Note B)

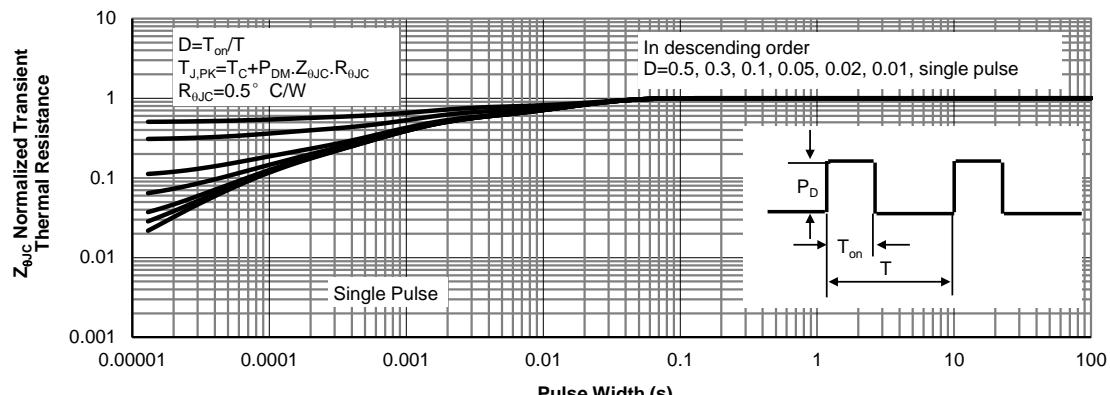
TYPICAL ELECTRICAL AND THERMAL CHARACTERISTICS


Figure 12: Normalized Maximum Transient Thermal Impedance for AOT10N60/AOB10N60 (Note F)

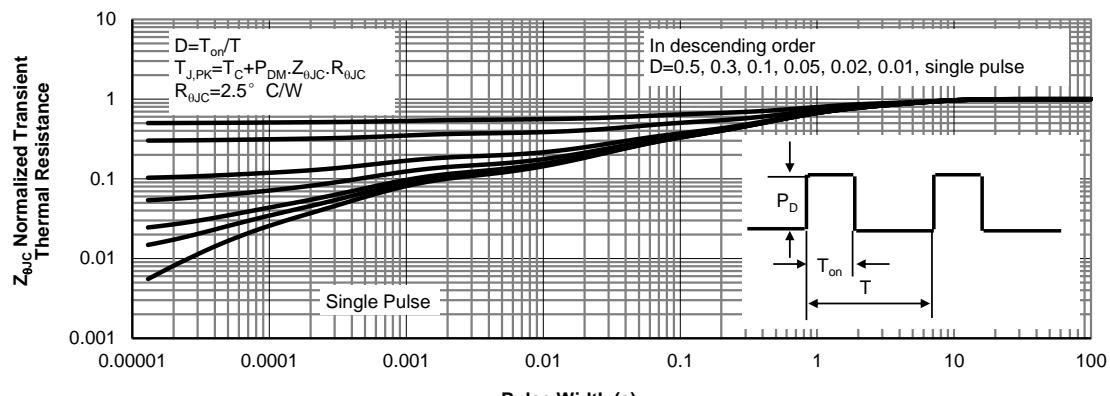
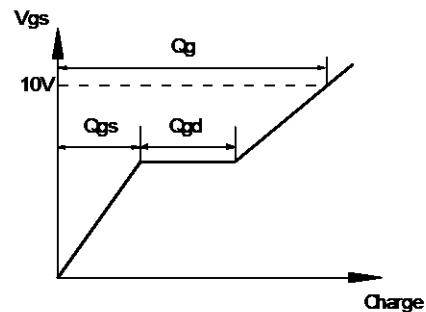
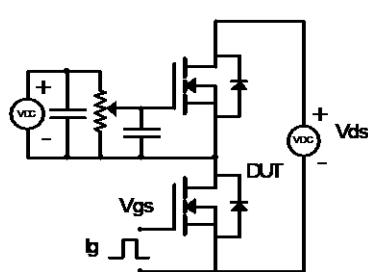
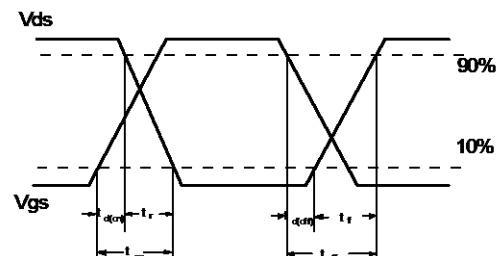
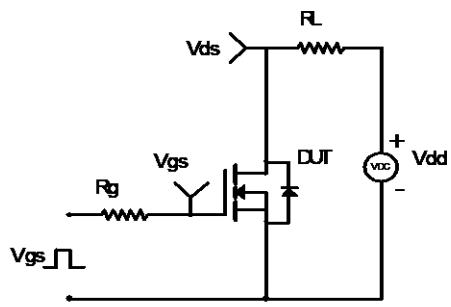
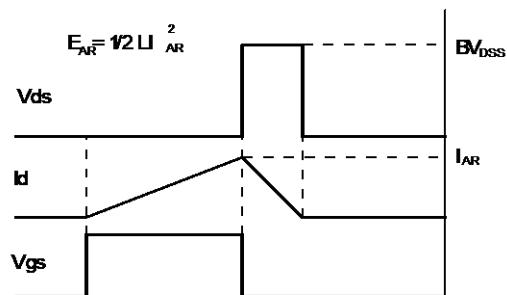
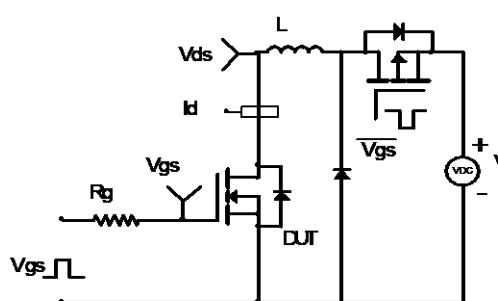


Figure 13: Normalized Maximum Transient Thermal Impedance for AOTF10N60 (Note F)

Gate Charge Test Circuit & Waveform

Resistive Switching Test Circuit & Waveforms

Unclamped Inductive Switching (UIS) Test Circuit & Waveforms

Diode Recovery Test Circuit & Waveforms
